

Vishay Semiconductors

Fast Avalanche Sinterglass Diode

Features

- · Glass passivated junction
- · Hermetically sealed package
- · Low reverse current
- · Soft recovery characteristics
- · Controlled avalanche characteristics

Applications

Fast "soft recovery" rectification diode

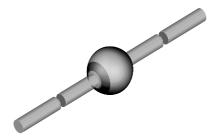
Mechanical Data

Case: Sintered glass case, SOD 64

Terminals: Plated axial leads, solderable per

MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end



949588

Mounting Position: Any

Weight: 860 mg, (max. 1000 mg)

Parts Table

Part	Type differentiation	Package			
BYT77	V _R = 800 V; I _{FAV} = 3 A	SOD64			
BYT78	V _R = 1000 V; I _{FAV} = 3 A	SOD64			

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Sub type	Symbol	Value	Unit
Reverse voltage	see electrical characteristics	BYT77	V _R =	800	V
			V_{RRM}		
	see electrical characteristics	BYT78	V _R =	1000	V
			V_{RRM}		
Peak forward surge current	$t_p = 10 \text{ ms}, \text{ half sinewave}$		I _{FSM}	100	Α
Average forward current	T _{amb} ≤ 45 °C		I _{FAV}	3	Α
Junction and storage temperature range			$T_j = T_{stg}$	- 55 to +175	°C
Non repetitive reverse avalanche energy	I _{(BR)R} = 0.4 A		E _R	10	mJ

Maximum Thermal Resistance

 T_{amb} = 25 °C, unless otherwise specified

and ,					
Parameter	Test condition Sub typ		Symbol	Value	Unit
Junction ambient	I = 10 mm, T _L = constant		R _{thJA}	25	K/W
	on PC board with spacing 25 mm		R _{thJA}	70	K/W

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Electrical Characteristics

 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Sub type	Symbol	Min	Тур.	Max	Unit
Forward voltage	I _F = 3 A		V_{F}		1.0	1.2	V
Reverse current	$V_R = V_{RRM}$		I _R		1	5	μА
	V _R = V _{RRM} , T _j = 150 °C		I _R		60	150	μΑ
Reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, i_R = 0.25 \text{ A}$		t _{rr}			250	ns

Typical Characteristics ($T_{amb} = 25$ °C unless otherwise specified)

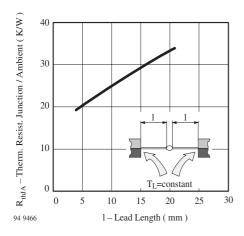


Figure 1. Max. Thermal Resistance vs. Lead Length

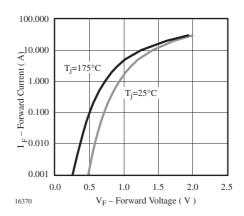


Figure 3. Forward Current vs. Forward Voltage

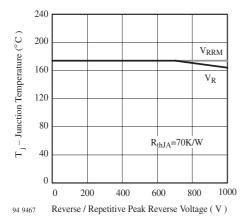


Figure 2. Junction Temperature vs. Reverse/Repetitive Peak Reverse Voltage

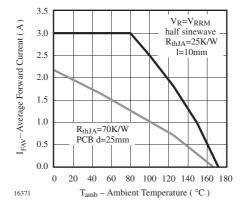


Figure 4. Max. Average Forward Current vs. Ambient Temperature



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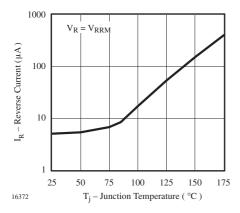


Figure 5. Reverse Current vs. Junction Temperature

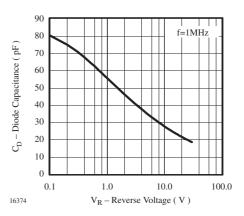


Figure 7. Diode Capacitance vs. Reverse Voltage

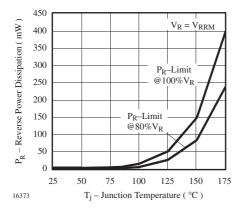
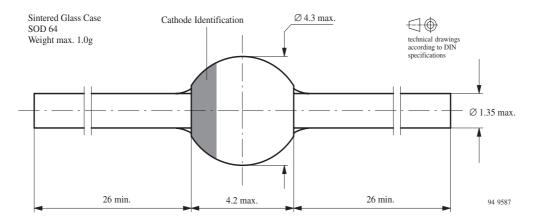


Figure 6. Max. Reverse Power Dissipation vs. Junction Temperature

Package Dimensions in mm



BYT77.BYT78

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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operatingsystems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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